NSN 5962-00-368-2866

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View Online at https://aerobasegroup.com/nsn/5962-00-368-2866
Body Length:
Between 1.100 inches and 1.250 inches
Body Width:
Between 0.490 inches and 0.580 inches
Body Height:
Between 0.080 inches and 0.105 inches
Maximum Power Dissipation Rating:
409.0 milliwatts
Operating Tempurature Range:
-55.0/+125.0 degrees celsius
Storage Tempurature Range:
-65.0/+150.0 degrees celsius
Features Provided:
Hermetically sealed and monolithic and positive outputs and bipolar and programmable and programmed and w/buffered output and
w/decoded output and w/open collector and w/enable and w/storage
Inclosure Material:
Ceramic and glass
Inclosure Configuration:
Dual-in-line Dual-in-line
Output Logic Form:
Transistor-transistor logic
Input Circuit Pattern:
14 input
Terminal Surface Treatment:
Solder
Voltage Rating And Type Per Characteristic:
5.5 volts power source
Time Rating Per Chacteristic:
70.00 nanoseconds propagation delay time, low to high level output and 175.00 nanoseconds propagation delay time, high to low level
output
Memory Device Type:
Rom
Memory Capacity:
Unknown
Test Data Document:
07187-4009238 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.;
excludes any specification, standard or other document that may be referenced in a basic governing drawing)
Terminal Type And Quantity:
24 printed circuit
Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

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